

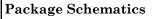
Part Number: XZURT54W-4

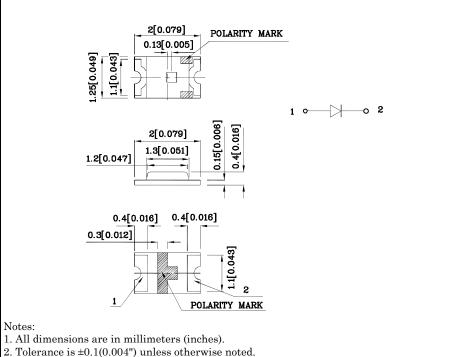
2.0x1.25mm SMD CHIP LED LAMP

Features

- Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- Package : 2000pcs / reel
- Moisture sensitivity level : level 3
- RoHS compliant







3. Specifications are subject to change without notice.

Notes:

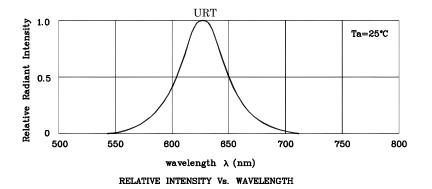
| Absolute Maximum Ratings (T _A =25°C) | | URT (GaAsP/GaP) | Unit |
|--|-------------|--------------------|------|
| Reverse Voltage | $V_{\rm R}$ | 5 | V |
| Forward Current | $I_{\rm F}$ | 30 | mA |
| Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width | ifs | 160 | mA |
| Power Dissipation | P_{D} | 75 | mW |
| Operating Temperature | TA | -40 ~ +85 | °C |
| Storage Temperature | Tstg | -40 ~ +85 | -C |

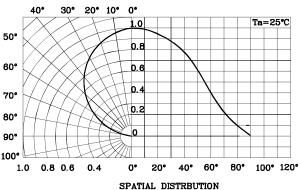
| Operating Characteristics (T _A =25°C) | | URT (GaAsP/GaP) | Unit |
|--|-------------------|--------------------|-------------|
| Forward Voltage (Typ.) (I _F =20mA) | $V_{\rm F}$ | 2 | V |
| Forward Voltage (Max.) (I _F =20mA) | $V_{\rm F}$ | 2.5 | V |
| Reverse Current (Max.) (V _R =5V) | I_R | 10 | uA |
| Wavelength of Peak Emission (Typ.) (I _F =20mA) | λP | 627 | nm |
| Wavelength of Dominant Emission (Typ.) (I _F =20mA) | λD | 625 | nm |
| Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA) | $	riangle\lambda$ | 45 | nm |
| Capacitance (Typ.) (V _F =0V, f=1MHz) | С | 15 | $_{\rm pF}$ |

| Part Number | Emitting Color | Emitting Material | Lens-color | Luminous Intensity (I _F =20mA) mcd | | Wavelength $nm \\ \lambda P$ | Viewing Angle 20 1/2 |
|----------------|-------------------|----------------------|-------------|--|------|------------------------------|----------------------------|
| | | | | min. | typ. | | |
| XZURT54W-4 | Red | GaAsP/GaP | Water Clear | 8 | 14 | 627 | 110° |

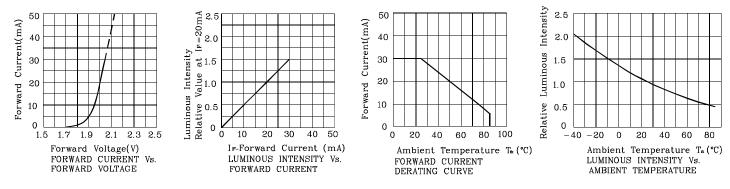
XDSA7253 V4 Layout: Maggie L.





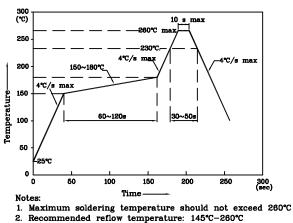


♦ URT



LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

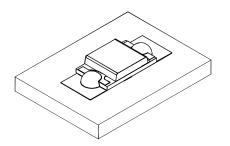


3. Do not put stress to the epoxy resin during

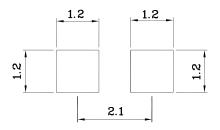
high temperatures conditions



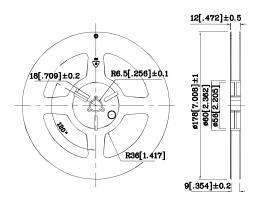
✤ The device has a single mounting surface. The device must be mounted according to the specifications.



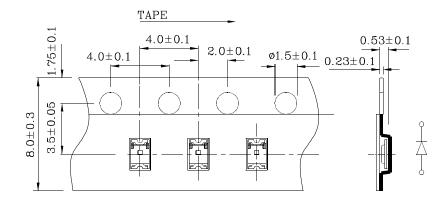
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V $\,$

Note: Accuracy may depend on the sorting parameters.

Apr 11,2011



PACKING & LABEL SPECIFICATIONS

